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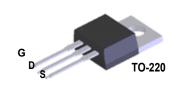
on Semiconductor* FQP27P06 P-Channel QFET[®] MOSFET - 60 V, - 27 A, 70 m Ω

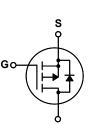
Description

This P-Channel enhancement mode power MOSFET is produced using ON Semiconductor's proprietary planar stripe and DMOS technology. This advanced MOSFET technology has been especially tailored to reduce on-state resistance, and to provide superior switching performance and high avalanche energy strength. These devices are suitable for switched mode power supplies, audio amplifier, DC motor control, and variable switching power applications.

Features

- - 27 A, 60 V, $R_{DS(on)}$ = 70 m Ω (Max.) @ V_{GS} = 10 V, I_D = 13.5 A
- Low Gate Charge (Typ. 33 nC)
- Low Crss (Typ. 120 pF)
- 100% Avalanche Tested
- 175°C Maximum Junction Temperature Rating





Absolute Maximum Ratings T_c = 25°C unless otherwise noted

Symbol	Parameter			FQP27P06	Unit	
V _{DSS}	Drain-Source Voltage			-60	V	
I _D	Drain Current	Drain Current - Continuous (T _C = 25°C)		-27	А	
	- Continuous (T _C = 100°C)		D°C)	-19.1	A	
I _{DM}	Drain Current	- Pulsed	(Note 1)	-108	А	
V _{GSS}	Gate-Source Voltage			± 25	V	
E _{AS}	Single Pulsed Avalanche Energy		(Note 2)	560	mJ	
I _{AR}	Avalanche Current		(Note 1)	-27	А	
E _{AR}	Repetitive Avalanche Energy		(Note 1)	12	mJ	
dv/dt	Peak Diode Recovery dv/dt		(Note 3)	-7.0	V/ns	
PD	Power Dissipation (T _C = 25°C) - Derate above 25°C			120	W	
				0.8	W/°C	
T _J , T _{STG}	Operating and Storage Temperature Range			-55 to +175	°C	
TL	Maximum lead temperature for soldering purposes,			300	°C	
	1/8" from case for 5 seconds			300	C	

Thermal Characteristics

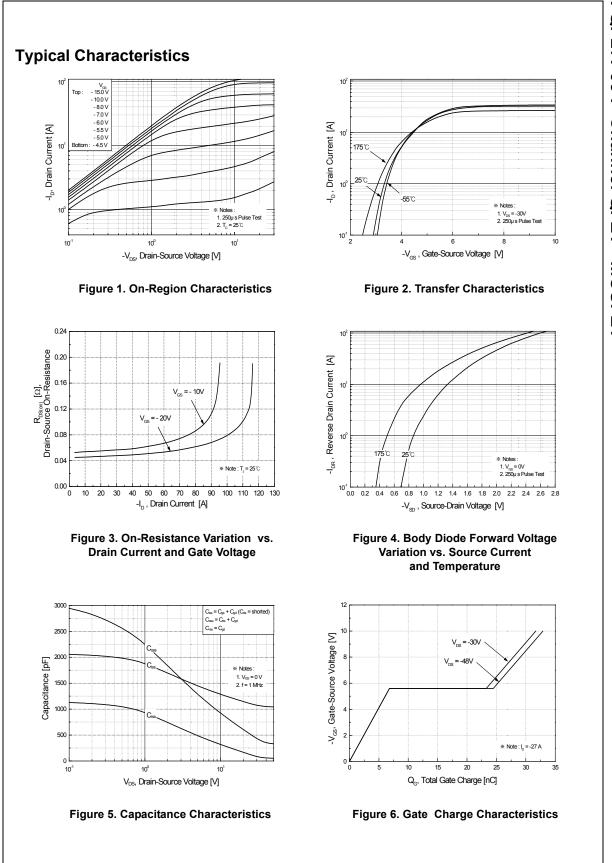
Symbol	Parameter	FQP27P06	Unit °C/W °C/W	
$R_{ ext{ heta}JC}$	Thermal Resistance, Junction-to-Case, Max.	1.25		
$R_{\theta CS}$	Thermal Resistance, Case-to-Sink, Typ.	0.5		
$R_{ ext{ heta}JA}$	Thermal Resistance, Junction-to-Ambient, Max.	62.5	°C/W	

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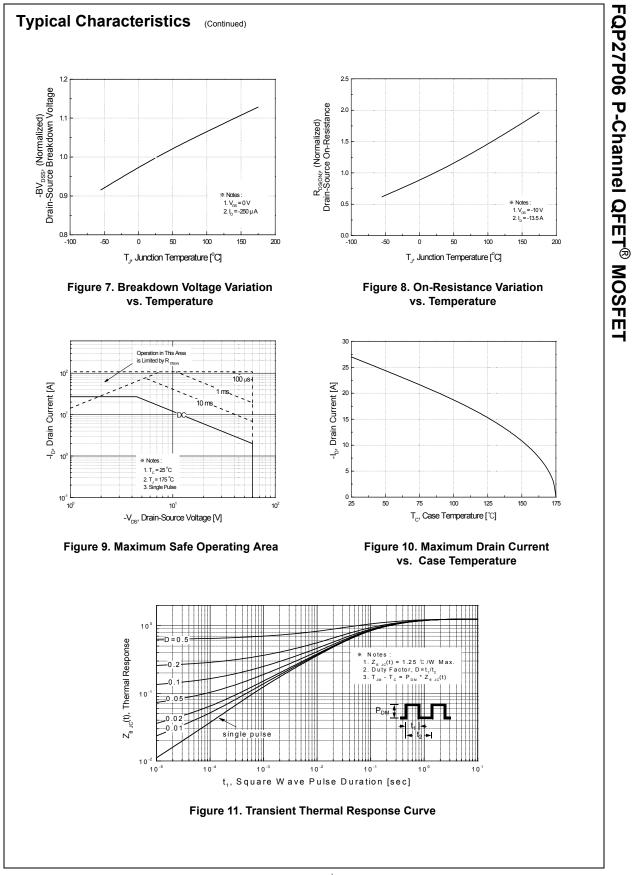
Publication Order Number: FQP27P06/D

Symbol	Parameter	Test Conditions	Min	Тур	Max	Unit
Off Cha	racteristics					
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} = 0 V, I _D = -250 μA	-60			V
ΔBV _{DSS} / ΔT _J	Breakdown Voltage Temperature Coefficient	I_D = -250 μ A, Referenced to 25	5°C	-0.06		V/°C
I _{DSS}	Zara Cata Valtaga Drain Current	V_{DS} = -60 V, V_{GS} = 0 V			-1	μA
	Zero Gate Voltage Drain Current	V _{DS} = -48 V, T _C = 150°C			-10	μA
I _{GSSF}	Gate-Body Leakage Current, Forward	V_{GS} = -25 V, V_{DS} = 0 V			-100	nA
I _{GSSR}	Gate-Body Leakage Current, Reverse	V_{GS} = 25 V, V_{DS} = 0 V			100	nA
On Cha	racteristics					
V _{GS(th)}	Gate Threshold Voltage	V _{DS} = V _{GS} , I _D = -250 μA	-2.0		-4.0	V
R _{DS(on)}	Static Drain-Source On-Resistance	V _{GS} = -10 V, I _D = -13.5 A		0.055	0.07	Ω
9 _{FS}	Forward Transconductance	V _{DS} = -30 V, I _D = -13.5 A		12.4		S
Dynami	ic Characteristics					
C _{iss}	Input Capacitance	V _{DS} = -25 V, V _{GS} = 0 V,		1100	1400	pF
C _{oss}	Output Capacitance	f = 1.0 MHz		510	660	pF
C _{rss}	Reverse Transfer Capacitance			120	155	pF
Switchi	ng Characteristics			18	45	ns
t _r	Turn-On Rise Time	V _{DD} = -30 V, I _D = -13.5 A,		185	380	ns
t _{d(off)}	Turn-Off Delay Time	R _G = 25 Ω		30	70	ns
t _f	Turn-Off Fall Time	(Note		90	190	ns
Q _g	Total Gate Charge	V _{DS} = -48 V, I _D = -27 A,		33	43	nC
Q _{gs}	Gate-Source Charge	$V_{\rm DS} = -40$ V, $I_{\rm D} = -27$ A, V _{GS} = -10 V		6.8		nC
Q _{gd}	Gate-Drain Charge	(Note	e 4)	18		nC
Drain-S	ource Diode Characteristics ar				-27	А
I _{SM}	Maximum Continuous Drain-Source Diode Forward Current Maximum Pulsed Drain-Source Diode Forward Current				-27	A
V _{SD}		raxing rules of the power of t			-4.0	V
t _{rr}	Reverse Recovery Time			105		ns
Q _{rr}	Reverse Recovery Charge	dl _F / dt = 100 A/µs		0.41		μC
L = 0.9mH, I $I_{SD} \leq$ -27A,	ating : Pulse width limited by maximum junction temper $_{AS} = -27A$, $V_{DD} = -25V$, $R_G = 25 \Omega$, Starting $T_J = 25^{\circ}C$ di/dt $\leq 300A/\mu$ s, $V_{DD} \leq BV_{DSS}$, Starting $T_J = 25^{\circ}C$ adependent of operating temperature					

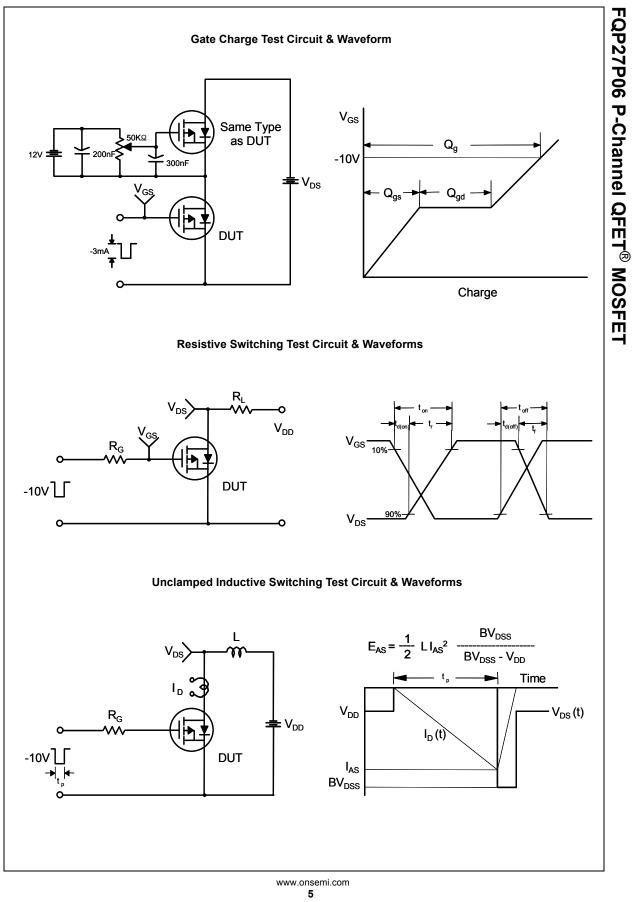
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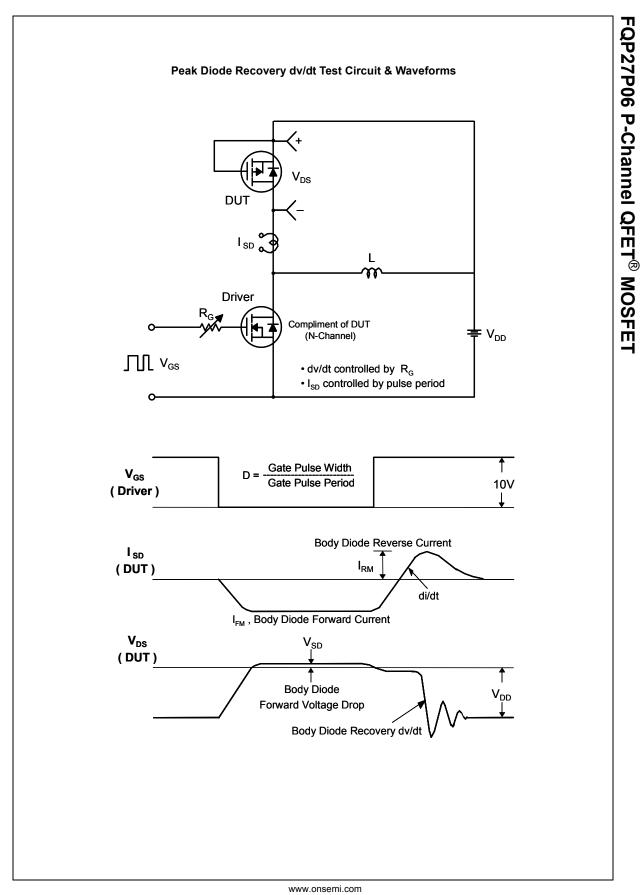


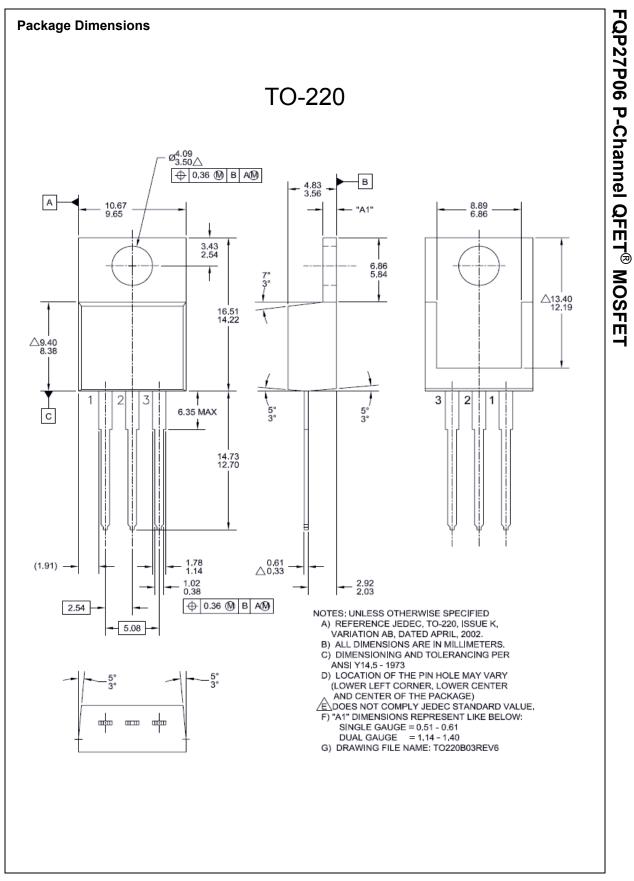
FQP27P06 P-Channel QFET® MOSFET



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